



Jalapeno is a very powerful quad-core CPU based module with dual band concurrent radio supporting 802.11ac Wave 2 technology

Jalapeno is based on an IPQ4018 SoC from Qualcomm, which is extremely powerful quad core 700MHz CPU Cortex A7 CPU with NEON (high-performance media engine), ideal for routers, gateways and access points. It is a surface mountable, dual-sided, Wi-Fi enabled Linux module.

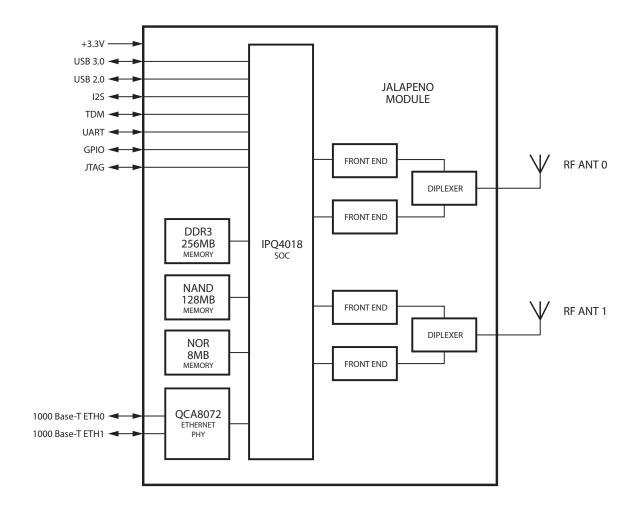
It comes with a high-power (23 dBm per chain) dual-band concurrent radio supporting 802.11ac Wave2 technology (2x2 MiMo) reaching 1.167 Gbps data rate. USB 3.0, USB 2.0, I2S, UART, GPIO are the interfaces available on the module together with two Gigabit Ethernet ports. SoC has hardware NAT engine and high-end security features like crypto engine, secure boot and others.

OpenWRT linux distribution source code is available on GitHub https://github.com/8devices and is supported by our growing community on http://www.8devices.com/community forum.

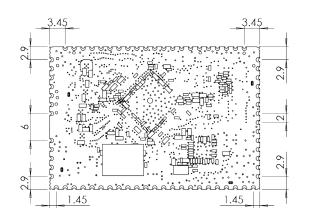
Quick specs

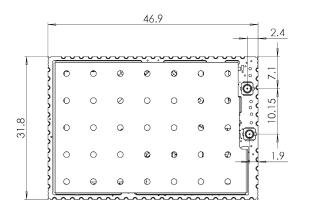
- 802.11 a/b/g/n/ac Wave 2, 2.4 and 5 GHz, 2x2 MIMO, 300 and 867 Mbps data rate, 23 dBm per chain output power
- U.FL connectors for external antenna
- 128 MB NAND and 8 MB NOR FLASH, 256 MB DDR3 RAM
- Linux friendly, OpenWRT flash image and source code are available for download on www.8devices.com/wiki_jalapeno
- CPU IPQ 4018 (700 MHz quad core Cortex A7)
- 23 dBm per chain output power dual-band concurrent radio with dedicated Tensilica CPL and 802.11ac Wave 2 support
- 32 by 47 mm size
- Surface mountable, dual-side design
- Available interfaces USB 2.0, USB 3.0, I2S, TDM, UART, GPIO, JTAG and 2 x 1000 Base-T Ethernet ports

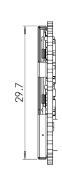
Block diagram



Module dimensions









Radio characteristics

| 2.4 GHz | Data rate (Mbps) | 14.4 | 28.9 | 43.3 | 57.8 | 86.7 | 115.6 | 130.3 | 144.4 | 173.3 | |
|-------------------|--------------------|------|------|------|------|------|-------|-------|-------|-------|-------|
| 802.11AC | Sensitivity (dBm) | -93 | -90 | -88 | -85 | 80 | -76 | -74 | -72 | -68 | |
| (20 MHz) | Output power (dBm) | 22 | 20 | 19 | 19 | 18 | 18 | 18 | 17 | 17 | |
| | | | | | | | | | | | |
| 2.4 GHz | Data rate (Mbps) | 30 | 60 | 90 | 120 | 180 | 240 | 270 | 300 | 360 | 400 |
| 802.11AC | Sensitivity (dBm) | -90 | -88 | -85 | -82 | -77 | -73 | -73 | -70 | -66 | -64 |
| (40 MHz) | Output power (dBm) | 21 | 19 | 18 | 18 | 18 | 18 | 17 | 17 | 17 | 17 |
| | | | | | | | | | | | |
| 5 GHz 802.11AC | Data rate (Mbps) | 14.4 | 28.9 | 43.3 | 57.8 | 86.7 | 115.6 | 130.3 | 144.4 | 173.3 | |
| | Sensitivity (dBm) | -92 | -89 | -86 | -83 | -80 | -76 | -74 | -73 | -68 | |
| (20 MHz) | Output power (dBm) | 22 | 20 | 19 | 19 | 18 | 18 | 18 | 17 | 17 | |
| | | | | | | | | | | | |
| 5 GHz | Data rate (Mbps) | 30 | 60 | 90 | 120 | 180 | 240 | 270 | 300 | 360 | 400 |
| 802.11AC | Sensitivity (dBm) | -89 | -86 | -84 | -81 | -78 | -73 | -72 | -70 | -66 | -67 |
| (40 MHz) | Output power (dBm) | 21 | 19 | 18 | 18 | 18 | 18 | 17 | 17 | 17 | 17 |
| | | | | | | | | | | | |
| 5 GHz | Data rate (Mbps) | 65 | 130 | 195 | 260 | 390 | 520 | 585 | 650 | 780 | 866.7 |
| 802.11AC | Sensitivity (dBm) | -86 | -83 | -80 | -77 | -74 | -70 | -69 | -67 | -63 | -61 |
| (80 MHz) | Output power (dBm) | 21 | 19 | 18 | 18 | 18 | 18 | 17 | 17 | 17 | 17 |

Power consumption

| Scenario | Voltage, V | Current, A | Power, W |
|---------------------------------|------------|------------|----------|
| Idle without beacons | 5 | 0.41 | 2.05 |
| Idle with beacons | 5 | 0.68 | 3.4 |
| MCS0 HT20 | 5 | 2.55 | 12.75 |
| MCS9 VHT80/HT40 (Highest rates) | 5 | 1.78 | 8.9 |

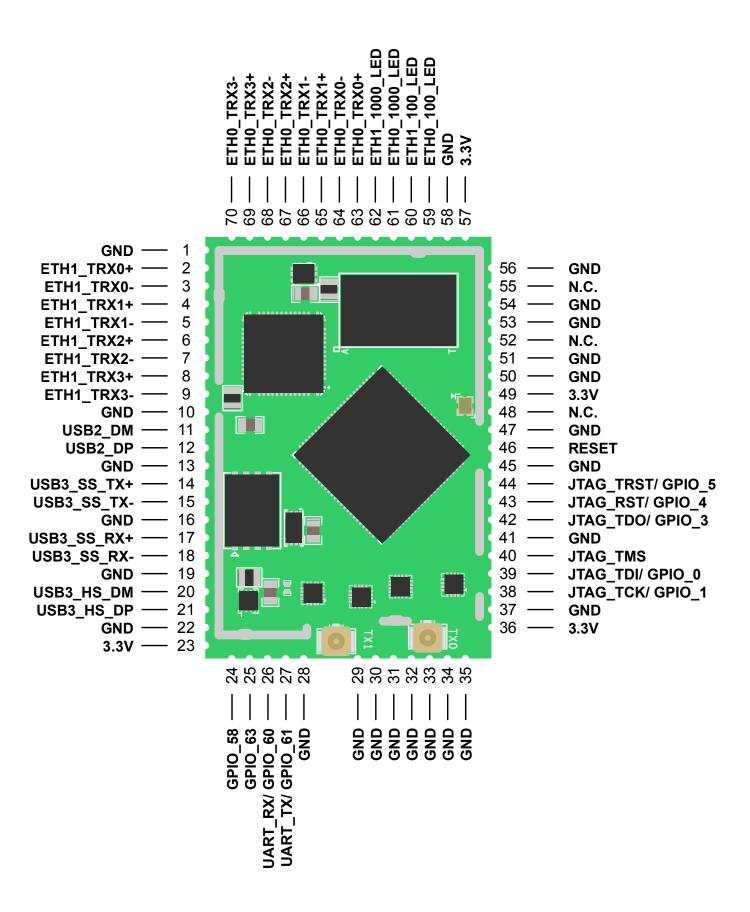
Operating conditions

The module can operate in a wide temperature range and different conditions depending on the enclosure. The following guidelines guarantee that it will work correctly.

| Parameter | Units | Min | Max |
|---------------------|-------|-----|-----|
| Working environment | °C | 0 | 55 |
| Storage environment | °C | -40 | 70 |
| Humidity | %RH | 10 | 90 |
| Storage humidity | %RH | 5 | 90 |

Heatsink size recommendations

It is essetial to use heatsink for the hardware designs based on Jalapeno module. Heatsink should be able to dissipate 7W and the recommended area is 175 cm². It should be directly attached to the bottom side of Jalapeno module.



Jalapeno Data sheet v1.2-18-2-20

| Pin | Name | GPIO function select | Configurable function | Voltage (V) | Туре | Description |
|-----|----------------|----------------------|-----------------------|-------------|--------|---|
| 1 | GND | - | - | - | - | Ground connection |
| 2 | ETH1_TRX0+ | - | - | - | AI, AO | 1000 Base-T output positive |
| 3 | ETH1_TRX0- | - | - | - | AI, AO | 1000 Base-T output negative |
| 4 | ETH1_TRX1+ | - | - | - | AI, AO | 1000 Base-T output positive |
| 5 | ETH1_TRX1- | - | - | - | AI, AO | 1000 Base-T output negative |
| 6 | ETH1_TRX2+ | - | - | - | AI, AO | 1000 Base-T output positive |
| 7 | ETH1_TRX2- | - | - | - | AI, AO | 1000 Base-T output negative |
| 8 | ETH1_TRX3+ | - | - | - | AI, AO | 1000 Base-T output positive |
| 9 | ETH1_TRX3- | - | - | - | AI, AO | 1000 Base-T output negative |
| 10 | GND | - | - | - | - | Ground connection |
| 11 | USB2_DM | - | - | - | AI, AO | USB 2.0 data negative |
| 12 | USB2_DP | - | - | - | AI, AO | USB 2.0 data positive |
| 13 | GND | - | - | - | - | Ground connection |
| 14 | USB3_SS_TX+ | - | - | - | AO | USB 3.0 SuperSpeed transmitter positive |
| 15 | USB3_SS_TX- | - | - | - | AO | USB 3.0 SuperSpeed transmitter negative |
| 16 | GND | - | - | - | - | Ground connection |
| 17 | USB3_SS_RX+ | - | - | - | Al | USB 3.0 SuperSpeed receiver positive |
| 18 | USB3_SS_RX- | - | - | - | Al | USB 3.0 SuperSpeed receiver negative |
| 19 | GND | - | - | - | - | Ground connection |
| 20 | USB3_HS_DM | - | - | - | AI, AO | USB 2.0 data negative |
| 21 | USB3_HS_DP | - | - | - | AI, AO | USB 2.0 data positive |
| 22 | GND | - | - | - | - | Ground connection |
| 23 | 3.3V | - | - | - | PI | 3.3V power supply |
| 24 | GPIO58 | 0 | GPIO | 3.3 | - | - |
| | | 2 | LED[2] | 3.3 | 0 | - |
| | | 5 | smart_ant6 | 3.3 | Ю | - |
| 25 | GPIO63 | 0 | GPIO | 3.3 | - | - |
| | | 5 | Audio_txd[1] | 3.3 | 0 | Audio transmit data |
| | | 6 | Audio_rxd | 3.3 | I | Audio receive data |
| 26 | UART_RX/GPIO60 | 0 | GPIO | 3.3 | - | - |
| | | 2 | blsp_uart0_rxd(1) | 3.3 | I | UART RX |
| | | 4 | smart_ant4 | 3.3 | Ю | - |
| | | 5 | LED[0] | 3.3 | 0 | - |
| | | 6 | audio_txbclk | 3.3 | Ю | Audio transmit bit block |
| | | 7 | audio_rxbclk | 3.3 | Ю | Audio receive bit block |
| 27 | UART_TX/GPIO61 | 0 | GPIO | 3.3 | - | - |
| | | 2 | blsp_uart0_txd | 3.3 | 0 | UART TX |
| | | 4 | smart_ant5 | 3.3 | Ю | - |
| | | 5 | audio_txfsync | 3.3 | Ю | Audio transmit frame sync |
| | | 6 | audio_rxfsync | 3.3 | Ю | Audio receiver frame sync |
| | | 7 | LED[1] | 3.3 | 0 | - |
| | | | boot_config(14) | 3.3 | I | - |
| | | | | | | |

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| Pin | Name | GPIO function select | Configurable function | Voltage (V) | Туре | Description |
|-----|------------------|----------------------|-----------------------|-------------|------|-------------------------------------|
| 28 | GND | - | - | - | - | Ground connection |
| 29 | GND | - | - | - | - | Ground connection |
| 30 | GND | - | - | - | - | Ground connection |
| 31 | GND | - | - | - | - | Ground connection |
| 32 | GND | - | - | - | - | Ground connection |
| 33 | GND | - | - | - | - | Ground connection |
| 34 | GND | - | - | - | - | Ground connection |
| 35 | GND | - | - | - | - | Ground connection |
| 36 | 3.3V | - | - | - | PI | 3.3V power supply |
| 37 | GND | - | - | - | - | Ground connection |
| 38 | JTAG_TCK/GPIO1 | 0 | GPIO | 3.3 | - | - |
| | | 1 | JTAG_TCK | 3.3 | I | JTAG test clock |
| 39 | JTAG_TDI/GPI00 | 0 | GPIO | 3.3 | - | - |
| | | 1 | JTAG_TDI | 3.3 | I | JTAG test data in |
| 40 | JTAG_TMS | 0 | GPIO | 3.3 | - | - |
| | | 1 | JTAG_TMS | 3.3 | I | JTAG test mode state |
| 41 | GND | - | - | - | - | Ground connection |
| 42 | JTAG_TDO/GPIO3 | 0 | GPIO | 3.3 | - | - |
| | | 1 | JTAG_TDO | 3.3 | 0 | JTAG test data out |
| | | - | boot_con- fig(0) | 3.3 | I | - |
| 43 | JTAG_RST_N/GPIO4 | 0 | GPIO | 3.3 | - | - |
| | | 1 | JTAG_RST_N | 3.3 | I | JTAG reset for debug |
| 44 | JTAG_TRST_N/ | 0 | GPIO | 3.3 | - | - |
| | GPIO5 | 1 | JTAG_ TRST_N | 3.3 | I | JTAG test reset |
| 45 | GND | - | - | - | - | Ground connection |
| 46 | Reset | - | Module reset | | 1 | 0 - reset, 1 - run |
| 47 | GND | - | - | - | - | Ground connection |
| 48 | NC | - | - | - | - | Not connected |
| 49 | 3.3V | - | - | - | PI | 3.3V power supply |
| 50 | GND | - | - | - | - | Ground connection |
| 51 | GND | - | - | - | - | Ground connection |
| 52 | NC | - | - | - | - | Not connected |
| 53 | GND | - | - | - | - | Ground connection |
| 54 | GND | - | - | - | - | Ground connection |
| 55 | NC | - | _ | - | - | Not connected |
| 56 | GND | - | - | - | - | Ground connection |
| 57 | 3.3V | - | - | - | PI | 3.3V power supply |
| 58 | GND | - | - | - | - | Ground connection |
| 59 | ETH0_100_LED | - | - | - | AO | LED output for 100 Base-T activity |
| 60 | ETH1_100_LED | - | - | - | AO | LED output for 100 Base-T activity |
| 61 | ETH0_1000_LED | - | - | - | AO | LED output for 1000 Base-T activity |
| 62 | ETH1_1000_LED | - | - | - | AO | LED output for 1000 Base-T activity |
| | | | | | | , |

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| Pin | Name | GPIO function select | Configurable function | Voltage (V) | Туре | Description |
|-----|------------|----------------------|-----------------------|-------------|--------|-----------------------------|
| 63 | ETH0_TRX0+ | - | - | - | AI, AO | 1000 Base-T output positive |
| 64 | ETH0_TRX0- | - | - | - | AI, AO | 1000 Base-T output negative |
| 65 | ETH0_TRX1+ | - | - | - | AI, AO | 1000 Base-T output positive |
| 66 | ETH0_TRX1- | - | - | - | AI, AO | 1000 Base-T output negative |
| 67 | ETH0_TRX2+ | - | - | - | AI, AO | 1000 Base-T output positive |
| 68 | ETH0_TRX2- | - | - | - | AI, AO | 1000 Base-T output negative |
| 69 | ETH0_TRX3+ | - | - | - | AI, AO | 1000 Base-T output positive |
| 70 | ETH0_TRX3- | - | - | - | AI, AO | 1000 Base-T output negative |

PI - Power input

IO - digital bi-directional signal

O - digital output

I - digital input

AO - analog output

AI - analog input

Power supply

It is recommended to use pin 23, 36, 49 and 57 to give power supply to the module.

Power ratings

| Parameter | Units | Min | Nominal | Max |
|-------------------|-------|------|---------|------|
| 3.3V power supply | V | 3.13 | 3.3 | 3.46 |

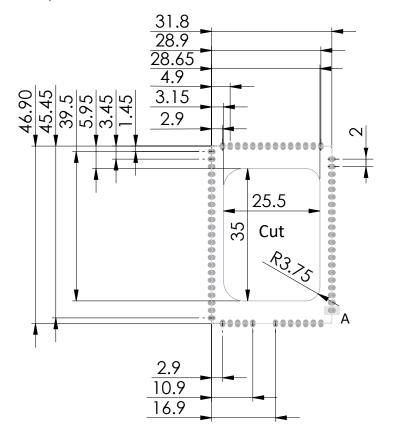
Digital I/O characteristics for 3.3V I/O

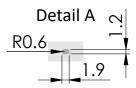
| Parameter | | Comments | Min | Max | Units |
|--------------------|----------------------------------|-----------------------------------|------|-----|-------|
| V _{IH} | High-level input voltage | CMOS/ Schmitt | 2 | 3.6 | V |
| V _{IL} | Low-level input voltage | CMOS/ Schmitt | -0.3 | 0.4 | V |
| V _{SHYS} | Schmitt hysteresis voltage | - | _ | - | mV |
| I _{IH} | Input high leakage current 11, 2 | No pulldown | _ | 1 | μΑ |
| I _{IL} | Input low leakage current 1, 2 | No pullup | -1 | - | μΑ |
| I _{IHPD} | Input high leakage current 1,3 | With pulldown | 10 | 60 | μΑ |
| I _{ILPU} | Input low leakage current 2, 3 | With pullup | -60 | -10 | μΑ |
| V _{OH} | High-level output voltage 4 | CMOS, at pin-rated drive strength | 3.0 | 3.6 | V |
| V _{OL} | Low-level output voltage 4 | CMOS, at pin-rated drive strength | -0.3 | 0.4 | V |
| I _{OZH} | Tri-state leakage current 1 | Logic high output, no pulldown | - | 1 | μΑ |
| I _{OZL} | Tri-state leakage current 2 | Logic low output, no pullup | -1 | - | μΑ |
| I _{OZHPD} | Tri-state leakage current 1,3 | Logic high output with pulldown | 10 | 60 | μΑ |
| I _{OZLPU} | Tri-state leakage current 2, 3 | Logic low output with pullup | -60 | -10 | μΑ |
| C _{IN} | Input capacitance ₅ | - | _ | 5 | pF |

Software

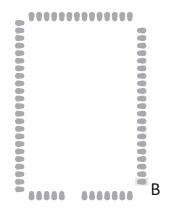
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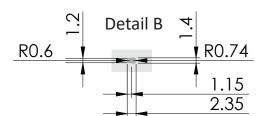
PCB footprint





Soldering paste footprint

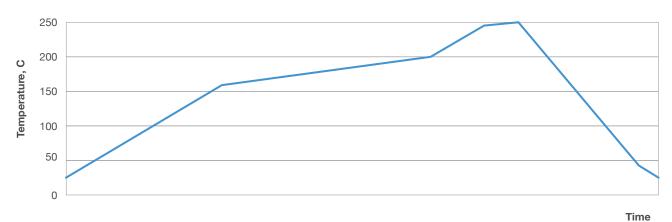




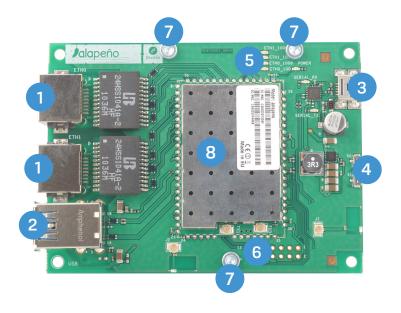
Reflow profile recommendation

| Ramp up rate | 3°C/second max |
|---|----------------|
| Maximum time maintained above 217°C | 120 seconds |
| Peak temperature | 250°C |
| Maximum time within 5°C of peak temperature | 20 seconds |
| Ramp down rate | 6°C/second max |

Reflow profile



Development kit



- 1 2 x 1000 Base-T Ethernet ports
- 2 2 x USB Type-A sockets (2.0 and 3.0)
- 3 Mini USB Type-A socket (console + power)
- 4 Buttons (reset and user GPIO connected)
- 5 External LEDs
- 6 2.45 mm pitch prototyping are holes
- 7 Heatsink mounting screws
- 8 Jalapeno module